PSMN3R9-25MLC

N-channel 25 V 4.15 mΩ logic level MOSFET in LFPAK33 using NextPower Technology

Rev. 4 — 15 June 2012 **Product data sheet**

1. Product profile

1.1 General description

Logic level enhancement mode N-channel MOSFET in LFPAK33 package. This product is designed and qualified for use in a wide range of industrial, communications and domestic equipment.

1.2 Features and benefits

- Low parasitic inductance and resistance
- Optimised for 4.5V Gate drive utilising NextPower Superjunction technology
- Ultra low QG, QGD, & QOSS for high system efficiencies at low and high loads

1.3 Applications

- DC-to-DC converters
- Load switching
- Synchronous buck regulator

1.4 Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Typ	Max	Unit
V_{DS}	drain-source voltage	T_j = 25°C		-	-	25	V
I_D	drain current	T_{mb} = 25 °C; V_{GS} = 10 V; see Figure 1	[1]	-	-	70	A
P_{tot}	total power dissipation	T_{mb} = 25 °C; see Figure 2		-	-	69	W
T_j	junction temperature			-55	-	175	°C
Static characteristics							
R_{DSon}	drain-source on-state resistance	V_{GS} = 4.5 V; I_D = 25 A; T_j = 25 °C; see Figure 10		-	4.85	5.55	mΩ
		V_{GS} = 10 V; I_D = 25 A; T_j = 25 °C; see Figure 10		-	3.65	4.15	mΩ
Dynamic characteristics							
Q_{GD}	gate-drain charge	V_{GS} = 4.5 V; I_D = 25 A; V_{DS} = 12.5 V; see Figure 12; see Figure 13		-	2.3	-	nC
$Q_{G(tot)}$	total gate charge	V_{GS} = 4.5 V; I_D = 25 A; V_{DS} = 12.5 V; see Figure 12; see Figure 13		-	9.7	-	nC

[1] Continuous current is limited by package.

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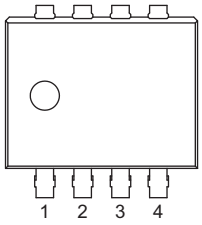
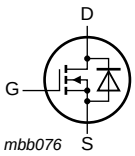
2. Pinning information

Table 2. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	S	source		
2	S	source		
3	S	source		
4	G	gate		
mb	D	mounting base; connected to drain		

SOT1210 (LFPAK33)

3. Ordering information

Table 3. Ordering information

Type number	Package		
	Name	Description	Version
PSMN3R9-25MLC	LFPAK33	Plastic single ended surface mounted package (LFPAK33); 4 leads	SOT1210

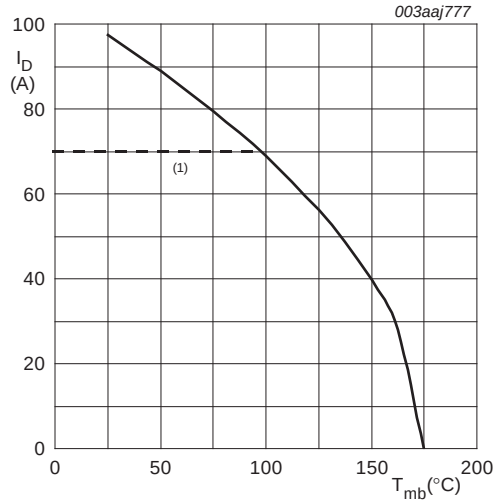
4. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions		Min	Max	Unit
V_{DS}	drain-source voltage	T_j = 25°C		-	25	V
V_{GS}	gate-source voltage			-20	20	V
I_D	drain current	V_{GS} = 10 V; T_{mb} = 25 °C; see Figure 1	[1]	-	70	A
		V_{GS} = 10 V; T_{mb} = 100 °C; see Figure 1		-	69	A
I_{DM}	peak drain current	pulsed; $t_p \leq 10$ µs; T_{mb} = 25 °C; see Figure 4		-	390	A
P_{tot}	total power dissipation	T_{mb} = 25 °C; see Figure 2		-	69	W
T_{stg}	storage temperature			-55	175	°C
T_j	junction temperature			-55	175	°C
$T_{sld(M)}$	peak soldering temperature			-	260	°C
V_{ESD}	electrostatic discharge voltage	MM (JEDEC JESD22-A115)		230	-	V
Source-drain diode						
I_S	source current	T_{mb} = 25 °C		-	63	A
I_{SM}	peak source current	pulsed; $t_p \leq 10$ µs; T_{mb} = 25 °C		-	390	A
Avalanche ruggedness						
$E_{DS(AL)S}$	non-repetitive drain-source avalanche energy	V_{GS} = 10 V; $T_{j(init)}$ = 25 °C; I_D = 70 A; $V_{sup} \leq 25$ V; R_{GS} = 50 Ω; unclamped; see Figure 3		-	34.5	mJ

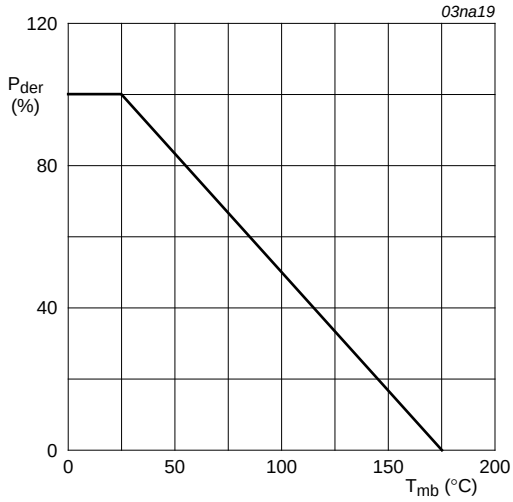
[1] Continuous current is limited by package.



$V_{GS} \geq 10\,V$

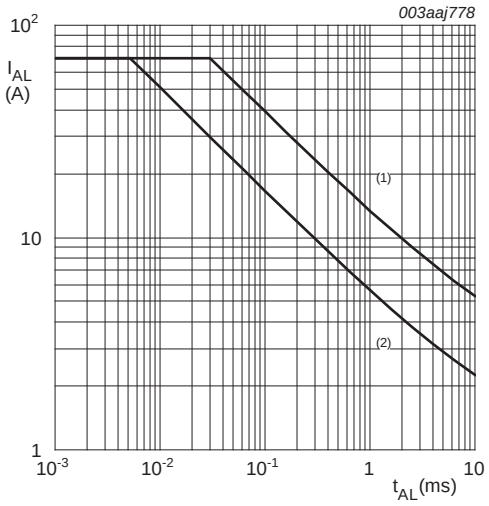
(1) Capped at 70 A due to package.

Fig 1. Continuous drain current as a function of mounting base temperature



$$P_{der} = \frac{P_{tot}}{P_{tot(25°C)}} \times 100\,\%$$

Fig 2. Normalized total power dissipation as a function of mounting base temperature



(1) $T_{j\,(init)} = 25°C$; (2) $T_{j\,(init)} = 100°C$

Fig 3. Single pulse avalanche rating; avalanche current as a function of avalanche time

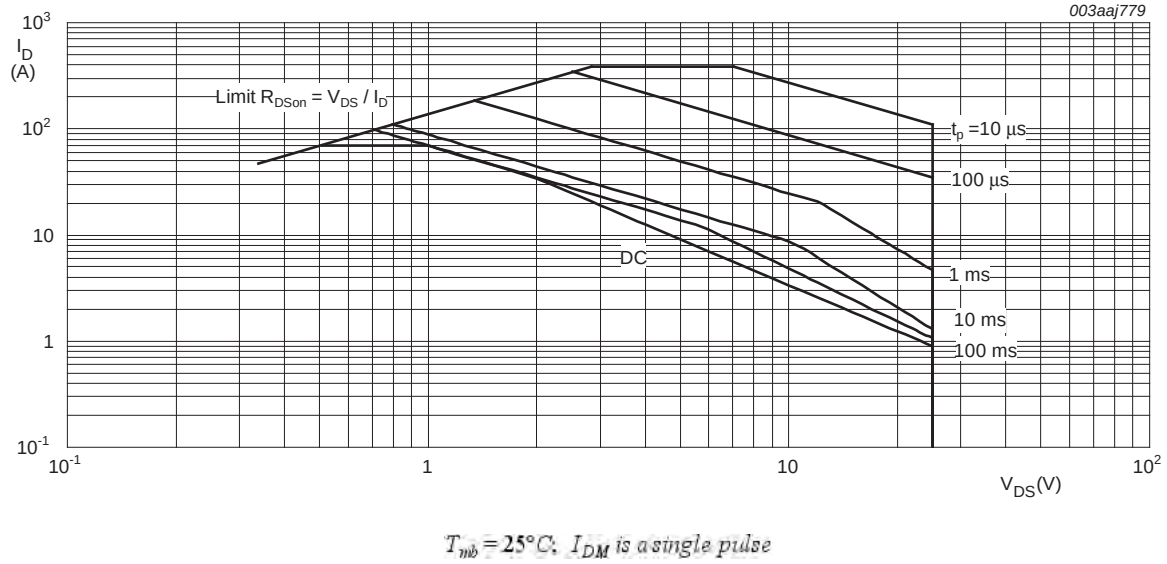


Fig 4. Safe operating area; continuous and peak drain currents as a function of drain-source voltage

5. Thermal characteristics

Table 5. Thermal characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$R_{th(j\text{-}mb)}$	thermal resistance from junction to mounting base	see Figure 5	-	1.95	2.18	K/W

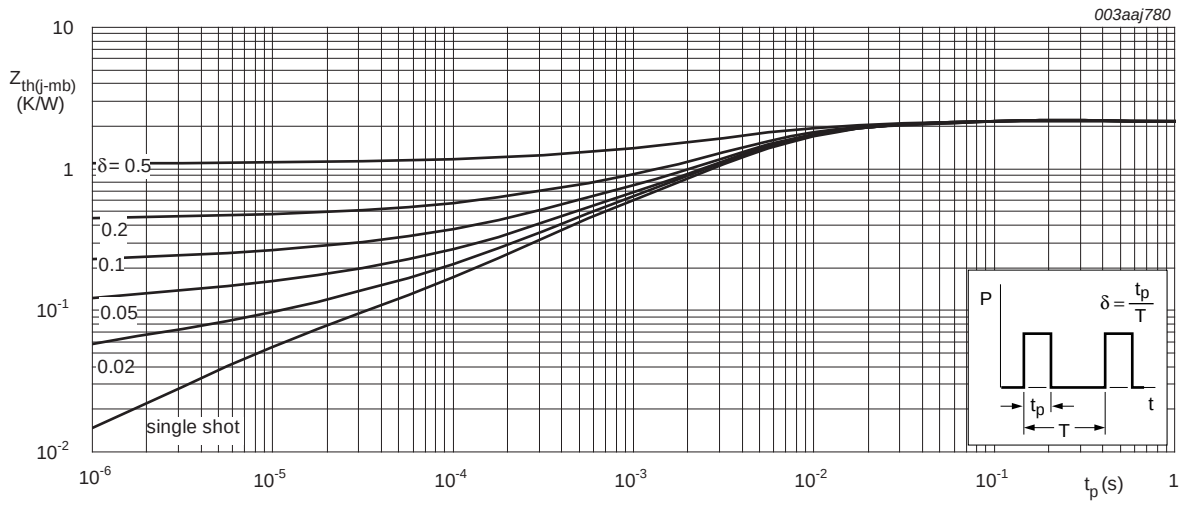


Fig 5. Transient thermal impedance from junction to mounting base as a function of pulse duration

6. Characteristics

Table 6. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Static characteristics						
$V_{(BR)DSS}$	drain-source breakdown voltage	I_D = 250 µA; V_{GS} = 0 V; T_j = 25 °C	25	-	-	V
		I_D = 250 µA; V_{GS} = 0 V; T_j = -55 °C	22.5	-	-	V
$V_{GS(th)}$	gate-source threshold voltage	I_D = 1 mA; V_{DS} = V_{GS}; T_j = 25 °C	1.45	1.81	2.15	V
$\Delta V_{GS(th)}/\Delta T$	gate-source threshold voltage variation with temperature		-	-4.1	-	mV/K
I_{DSS}	drain leakage current	V_{DS} = 25 V; V_{GS} = 0 V; T_j = 25 °C	-	-	1	µA
		V_{DS} = 25 V; V_{GS} = 0 V; T_j = 150 °C	-	-	100	µA
I_{GSS}	gate leakage current	V_{GS} = 16 V; V_{DS} = 0 V; T_j = 25 °C	-	-	100	nA
		V_{GS} = -16 V; V_{DS} = 0 V; T_j = 25 °C	-	-	100	nA
R_{DSon}	drain-source on-state resistance	V_{GS} = 4.5 V; I_D = 25 A; T_j = 25 °C; see Figure 10	-	4.85	5.55	mΩ
		V_{GS} = 4.5 V; I_D = 25 A; T_j = 150 °C; see Figure 10; see Figure 11	-	-	8.9	mΩ
		V_{GS} = 10 V; I_D = 25 A; T_j = 25 °C; see Figure 10	-	3.65	4.15	mΩ
		V_{GS} = 10 V; I_D = 25 A; T_j = 150 °C; see Figure 10; see Figure 11	-	-	6.65	mΩ
R_G	gate resistance	f = 1 MHz	0.9	1.8	3.6	Ω
Dynamic characteristics						
$Q_{G(tot)}$	total gate charge	I_D = 25 A; V_{DS} = 12.5 V; V_{GS} = 10 V; see Figure 12; see Figure 13	-	21.5	-	nC
		I_D = 25 A; V_{DS} = 12.5 V; V_{GS} = 4.5 V; see Figure 12; see Figure 13	-	9.7	-	nC
		I_D = 0 A; V_{DS} = 0 V; V_{GS} = 10 V	-	20.9	-	nC
Q_{GS}	gate-source charge	I_D = 25 A; V_{DS} = 12.5 V; V_{GS} = 4.5 V; see Figure 12; see Figure 13	-	3.9	-	nC
$Q_{GS(th)}$	pre-threshold gate-source charge		-	2.4	-	nC
$Q_{GS(th-pl)}$	post-threshold gate-source charge		-	1.5	-	nC
Q_{GD}	gate-drain charge		-	2.3	-	nC
$V_{GS(pl)}$	gate-source plateau voltage	I_D = 25 A; V_{DS} = 12.5 V; see Figure 12; see Figure 13	-	2.9	-	V
C_{iss}	input capacitance	V_{DS} = 12.5 V; V_{GS} = 0 V; f = 1 MHz; T_j = 25 °C; see Figure 14	-	1524	-	pF
C_{oss}	output capacitance		-	376	-	pF
C_{rss}	reverse transfer capacitance		-	128	-	pF

Table 6. Characteristics *…continued*

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
$t_{d(on)}$	turn-on delay time	V_{DS} = 12.5 V; R_L = 0.5 Ω; V_{GS} = 4.5 V; $R_{G(ext)}$ = 5 Ω	-	13	-	ns
t_r	rise time		-	23.2	-	ns
$t_{d(off)}$	turn-off delay time		-	15.6	-	ns
t_f	fall time		-	9.8	-	ns
Q_{oss}	output charge	V_{GS} = 0 V; V_{DS} = 12.5 V; f = 1 MHz; T_j = 25 °C	-	9.9	-	nC
Source-drain diode						
V_{SD}	source-drain voltage	I_S = 25 A; V_{GS} = 0 V; T_j = 25 °C; see Figure 15	-	0.82	1.1	V
t_{rr}	reverse recovery time	I_S = 25 A; dI_S/dt = -100 A/µs; V_{GS} = 0 V; V_{DS} = 12.5 V	-	17.6	-	ns
Q_r	recovered charge		-	9.2	-	nC
t_a	reverse recovery rise time	V_{GS} = 0 V; I_S = 25 A; dI_S/dt = -100 A/µs; V_{DS} = 12.5 V; see Figure 16	-	9.8	-	ns
t_b	reverse recovery fall time		-	7.8	-	ns

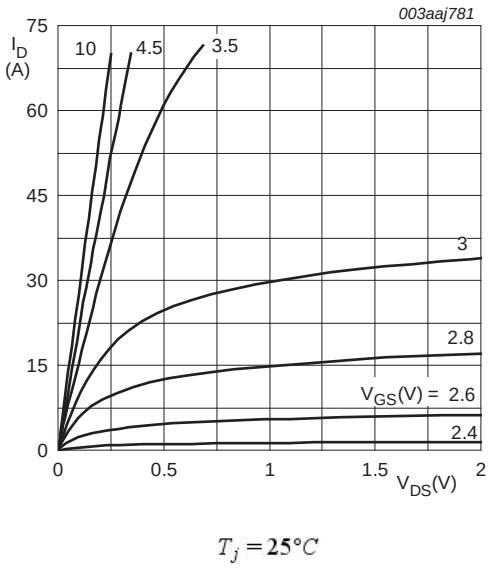


Fig 6. Output characteristics; drain current as a function of drain-source voltage; typical values

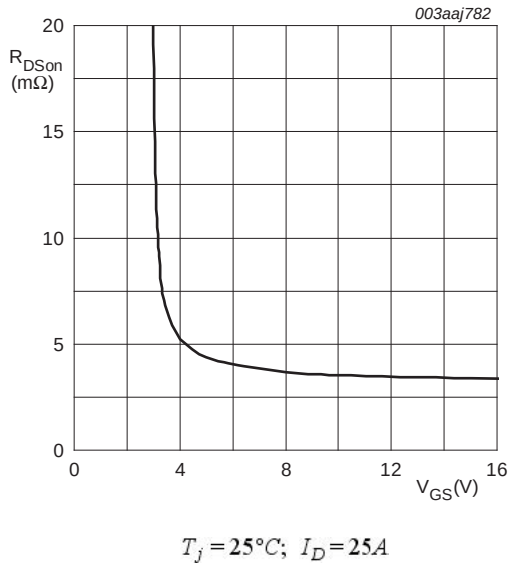
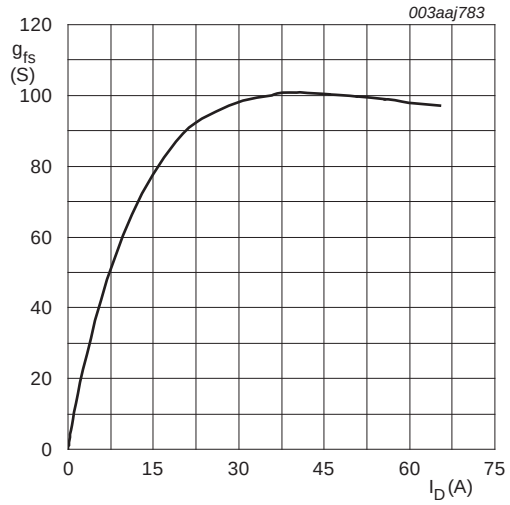
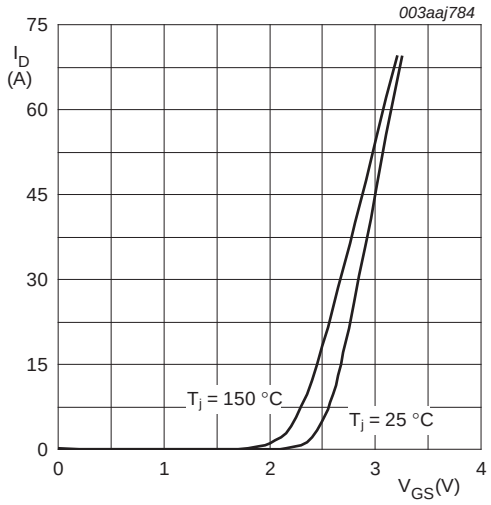


Fig 7. Drain-source on-state resistance as a function of gate-source voltage; typical values



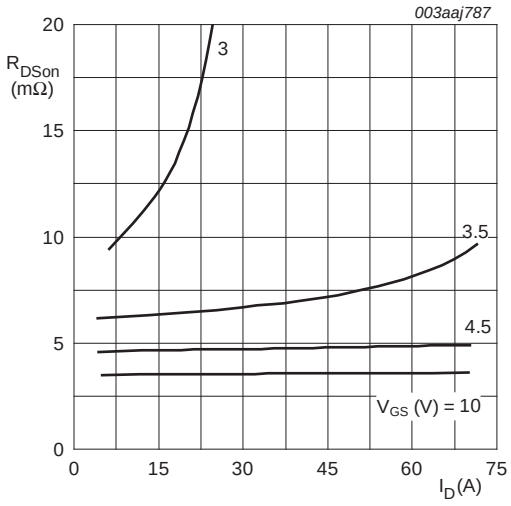
$T_j = 25°C;\ V_{DS} = 10V$

Fig 8. Forward transconductance as a function of drain current; typical values



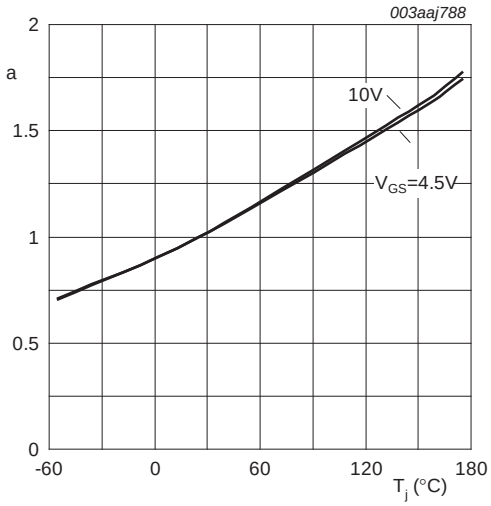
$V_{DS} = 10V$

Fig 9. Transfer characteristics; drain current as a function of gate-source voltage; typical values



$T_j = 25°C$

Fig 10. Drain-source on-state resistance as a function of drain current; typical values



$$a = \frac{R_{DSon}}{R_{DSon(25°C)}}$$

Fig 11. Normalized drain-source on-state resistance factor as a function of junction temperature

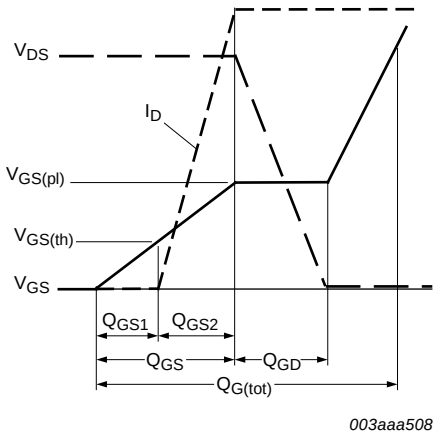
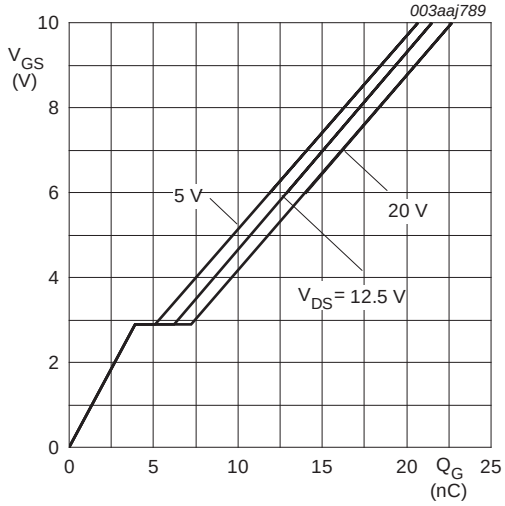
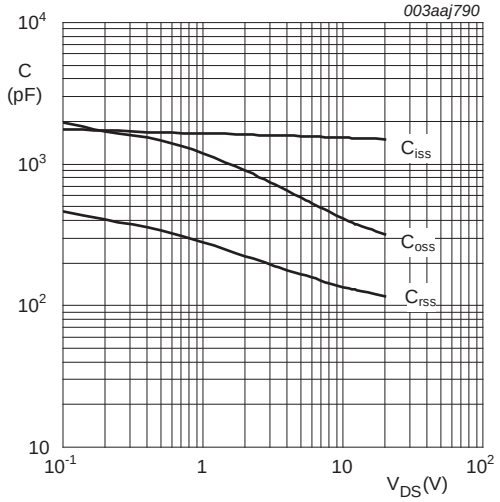


Fig 12. Gate charge waveform definitions



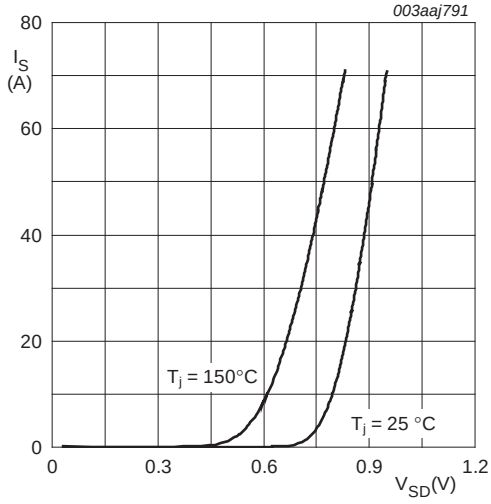
$T_j = 25°C;\ I_D = 25A$

Fig 13. Gate-source voltage as a function of gate charge; typical values



$V_{GS} = 0V;\ f = 1MHz$

Fig 14. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values



$V_{GS} = 0V$

Fig 15. Source current as a function of source-drain voltage; typical values

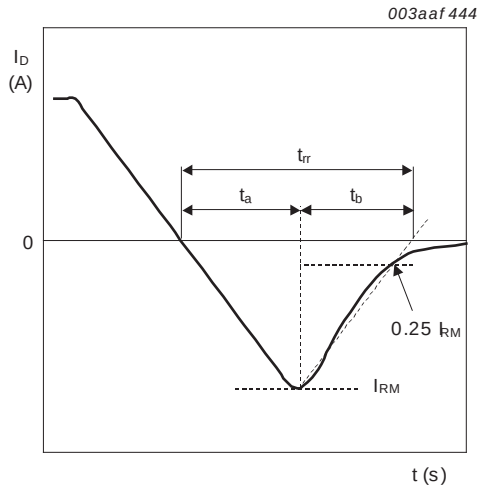
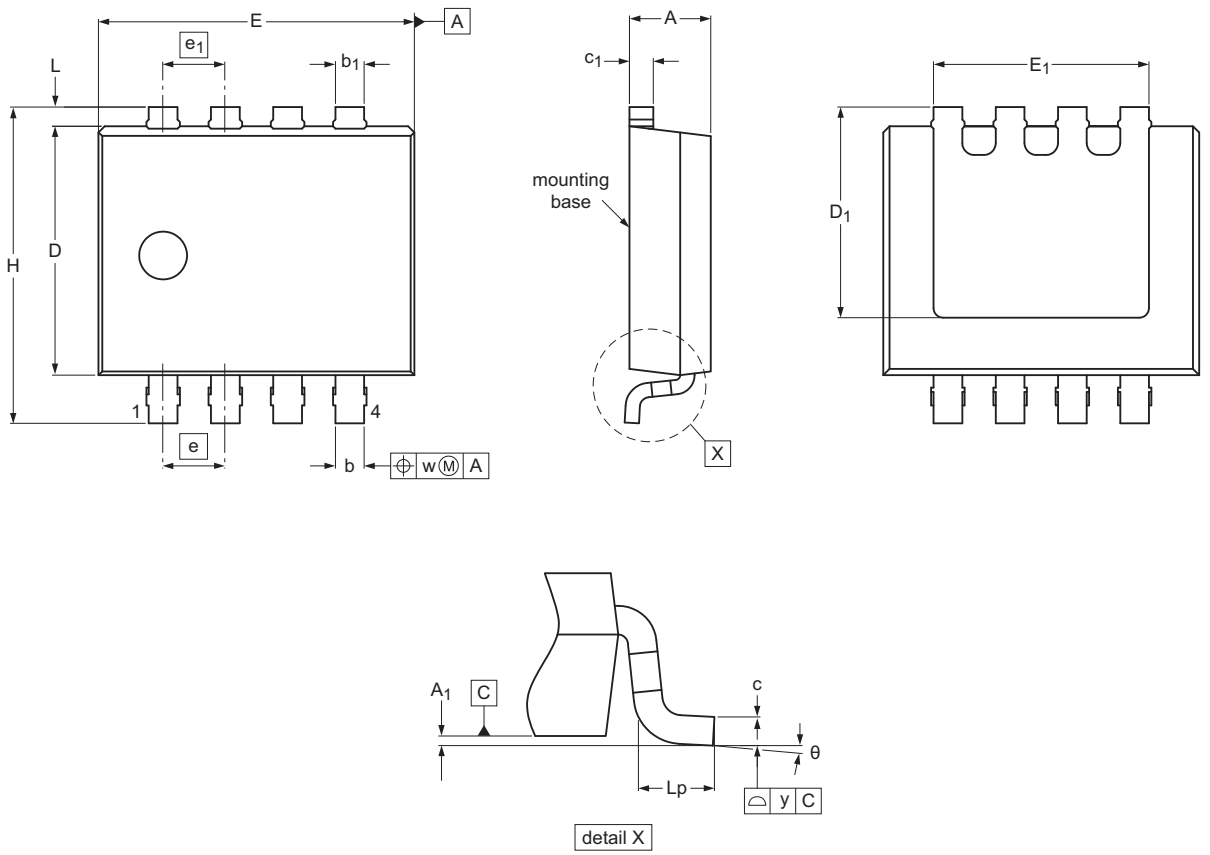
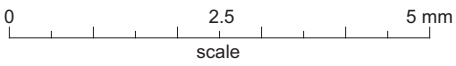


Fig 16. Reverse recovery timing definition

7. Package outline

Plastic single ended surface mounted package (LFPAK33); 8 leads **SOT1210**





Dimensions

Unit[1]		A	A_1	b	b_1	c	c_1	$D^{(1)}$	D_1	$E^{(1)}$	E_1	e	e_1	H	L	L_p	w	y	θ
mm	max	0.90	0.10	0.35	0.35	0.20	0.30	2.70	2.35	3.40	2.45			3.40	0.25	0.50			8°
	nom											0.65	0.65				0.20	0.10	
	min	0.80	0.00	0.25	0.25	0.10	0.20	2.50	1.90	3.20	2.00			3.20	0.13	0.30			0°

Note
1. Plastic or metal protrusions of 0.15 mm per side are not included.

sot1210_po

Outline version	References				European projection	Issue date
	IEC	JEDEC	JEITA			
SOT1210						~~11-12-19~~ 12-03-12

Fig 17. Package outline SOT1210 (LFPAK33)

8. Revision history

Table 7. Revision history

Document ID	Release date	Data sheet status	Change notice	Supersedes
PSMN3R9-25MLC v.4	20120615	Product data sheet	-	PSMN3R9-25MLC v.3
Modifications:	• Various changes to content.			
PSMN3R9-25MLC v.3	20120607	Product data sheet	-	PSMN3R9-25MLC v.2

9. Legal information

9.1 Data sheet status

Document status[1] [2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

[2] The term 'short data sheet' is explained in section "Definitions".

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10. Contact information

For more information, please visit:http://www.nexperia.com

For sales office addresses, please send an email to:salesaddresses@nexperia.com

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Date of release: 15 June 2012